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	1.	Purpose	versus	Application	characteristics	; :
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The specifications are applicable to Multi-layer Ceramic Chip Capacitor (MLCC): ■ Universal; □ Automotive Grade; 2. The term / Definition:: 2.1 Structural design classification: ■General; □ Ultra Micro; □ High Capacitance; □ High-Q; ☐ High-voltage 2.2 Chip Size: □01005、□0201、■0402、■0603、■0805、■1206、___(Others); 2.3 Capacitance range: 0.1pF~1µF; 2.4 Voltage range: 6.3V~50V;

ADD: Viiyong Hi-Tech Park, No.1 Chuangye 2nd Road, Shuangdong Sub-district, 527200, Luoding City, Guangdong

Province, P. R. China

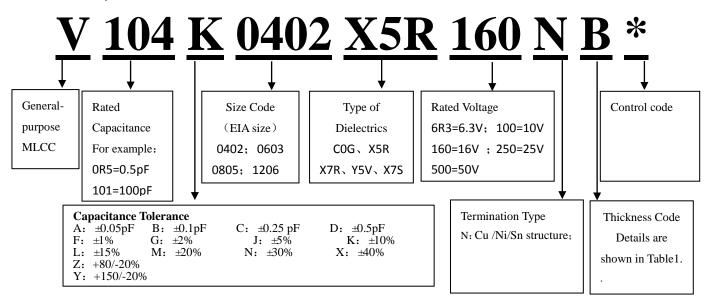
Postcode: 527200 TEL: 0766-3810639 FAX: 0766-3810639

Mark: The product specification is only for reference of design selection, not used as the basis for delivery

2.5 Type of Dielectrics: $\blacksquare COG$, $\blacksquare X7R$, $\blacksquare X5R$, $\blacksquare Y5V$, $\blacksquare X7S$, ____(Others);

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3. Part Number System:



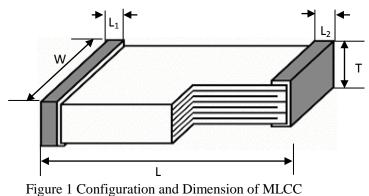


Table 1 Dimension of MLCC (Unite: mm)

Size	Langth (L)	Width (W)	Width of Termination	Thickness	Thickness
Size	Lengui (L)	Length (L) Width (W)		(T)	code
0.402	1.00±0.05	0.50±0.05	0.10~0.35	0.50±0.05	В
0402	1.00 ^{+0.15} _{-0.05}	$0.50^{+0.13}_{-0.05}$	0.10~0.35	$0.50^{+0.13}_{-0.05}$	N
0603	1.60±0.10	0.80±0.10	0.15~0.60	0.80±0.10	D
0005	2.00±0.20	1.25 ±0.20	0.20~0.75	$0.85^{+0.15}_{-0.35}$	Y
0805	2.00 ^{+0.20} -0.30	$1.25^{+0.20}_{-0.30}$	0.20~0.75	1.25 ^{+0.20} _{-0.30}	Н
	3.20±0.20	1.60±0.20	0.25~0.75	$0.85^{+0.15}_{-0.35}$	Y
1206	3.20±0.20	1.60±0.20	0.25~0.75	1.15±0.20	О
	3.20±0.20	1.60±0.20	0.25~0.75	1.60±0.20	L

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Table 2 Type of dielectrics

Type of Dielectrics	Operating Temperature Range	Temperature Coefficient or Characteristic		
NP0	-55℃~+125℃	C0G: 0±30ppm/°C		
NFU	-33 C + 123 C	C0H: 0±60ppm/°C		
X7R	-55°C ∼+125°C	±15%		
X5R	-55℃~+85℃	±15%		
Y5V	-30℃~+85℃	+22/-82%		
X7S	-55°C ∼+125°C	±22%		

Table 3 Rated Voltage and Rated Capacitance

a.	Rate voltage			Capacitance			Thickness
Size	$/U_R$	C0G	X7R	X5R	Y5V	X7S	code
		0.1pF~1.0nF	100pF∼68nF	100pF∼100nF	100pF∼68nF	_	В
	50V	360pF∼1.0nF	22nF∼68nF	22nF~100nF	22nF∼68nF	_	N
	-	_	100nF	_	_	_	С
	35V		100nF	100nF	_	_	В
	25V	$0.1 \mathrm{pF}{\sim}1.0 \mathrm{nF}$	22nF~100nF	10nF∼220nF	$10 \text{nF} \sim 68 \text{nF}$	_	В
0402	23 v	470pF~1.0nF	100nF	82nF~220nF	100nF	_	N
	16V	_	56nF∼100nF	47nF∼470nF	47nF∼150nF	_	В
	10 V	_	_	120nF∼470nF	150nF~220nF	_	N
	10V	_	_	100nF∼470nF	100nF	120nF∼220nF	В
		_	_	100nF∼470nF	150nF~220nF	120nF∼470nF	N
	6.3V	_	—	100nF∼470nF	—	120nF∼470nF	В
	6.3V		—	100nF∼470nF	220nF		N
	50V	1pF∼2.2nF	220pF~100nF	220pF~100nF	220pF~220nF	_	D
0603	25V	2.7nF∼3.9nF	100nF∼390nF	100nF∼220nF	100nF∼220nF	_	D
	16V	_	100nF∼390nF	220nF~470nF	220nF~470nF	_	D
	50V	10pF∼4.7nF	220pF~100nF	220pF~100nF	220pF~100nF	_	Y
	30 V	1.0nF∼5.6nF	100nF∼820nF	100nF∼820nF	100nF∼680nF	_	Н
0805	25V	1.0nF∼10nF	_	_	_	_	Y
	23 V	_	220nF~820nF	220nF~820nF	220nF~680nF	_	Н
	16V	_	1.0μF	1.0µF	1.0µF	_	Н
	50V	_	100nF	_	100nF	_	Y
1206	JU V	<u> </u>	100nF~1.0μF	_	100nF~1.0μF		L
1200	25V			_		_	
	16V		1.0μF		1.0µF	_	0

Note: 1) E12 series for X7R, X5R and X7S groups, E6 series for Y5V group, E24 series for C0G group, integer nominal values such as 1.0, 2.0, 3.0pF, etc. are allowed for the specifications below 10pF.

²⁾ For products of the same size, material and capacity, the rated voltage can be covered from high to low.

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Type of Packing:

Reel Packaging (standard carrier tape disc packaging), every disc smallest package are shown in Table 4.

Table 4 Packing type

Chip Size	(0402	0603	08	305	12	206
Thickness code	B/N	B/N	D	Н	Y	L/O	Y
Disc size	7"	13"	7"	7"	7"	7"	7"
Carrier Tape type	Paper	Paper	Paper	Plastic	Paper	Plastic	Paper
QTY (Kpcs)	10	50	4	2	4	2	4

First packaging: Each multi-disc material is packed into a box.

The second packaging: the first packaged packaging box is loaded into the paper packaging box, and the remaining space in the box is filled with light auxiliary materials. The above packaging forms can also be packaged according to user needs.

- 4. Specifications and Test Methods:
- 4.1 Visual Inspection:
- 4.1.1 Requirement: no obvious defects on ceramic body and termination.
- 4.1.2 Test Method: Microscope 10×.
- 4.2 Size:
- 4.2.1 Requirement: Configuration and dimension of MLCC are shown in Figure 1 and Table 1.
- 4.2.2 Test Method: Measuring by gages which precision is not less than 0.01 mm.

4.3 Operating Environment:

C0G/C0H(NP0), X7R	Temperature: -55°C \sim +125°C; Relative humidity: \leq 95%(25°C)	Atmosphere: 86kPa ~106KPa
X5R	Temperature: $-55^{\circ}\text{C} \sim +85^{\circ}\text{C}$; Relative humidity: $\leq 95\% (25^{\circ}\text{C})$	Atmosphere: 86kPa ∼106KPa
Y5V	Temperature: $-30^{\circ}\text{C} \sim +85^{\circ}\text{C}$; Relative humidity: $\leq 95\%$ (25°C)	Atmosphere: 86kPa ∼106KPa
X7S	Temperature: -30°C ~+125°C; Relative humidity: ≤95% (25°C)	Atmosphere: 86kPa ~106KPa

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4.4 Electrical Parameters and Test Methods:

Table 5 Specifications and Test Methods of MLCC Electrical Parameter

No.	Item	Sŗ	pecification	Test Method
1	Capacitance (C)	Within the		
2	Tangent of Loss Angle/ (tgδ)	$\begin{array}{c} C0G/C0H(NP0)\colon C\geq 30pl\\ C<30pl\\ X7R\colon\\ U_R=50V tg\delta\leq 350\times 10^{-4}\\ U_R=25V tg\delta\leq 480\times 10^{-4}\\ U_R\leq 16V tg\delta\leq 500\times 10^{-4}\\ \end{array}$ $\begin{array}{c} Y5V\colon U_R\geq 25V tg\delta\leq 95\\ U_R=16V tg\delta\leq 1\\ U_R\leq 10V tg\delta\leq 16\\ X7S\colon\\ U_R\geq 25V tg\delta\leq 1000\times 10^{-4};\\ U_R=16V tg\delta\leq 1250\times 10^{-4};\\ U_R=10V tg\delta\leq 1250\times 10^{-4};\\ U_R\leq 6.3V tg\delta\leq 1500\times 10^{-4} \end{array}$	Temperature: 18~28°C; Humidity: ≤RH 80%; Test frequency: C0G/C0H(NP0): C≤1000pF, f=1MHz±10%; C>1000pF, f=1KHz±10% X7R、 X5R、 Y5V、 X7S: C≤100pF, f=1MHz±10%; C>100pF, f=1KHz±10% Test Voltage: C≤100pF 1.0±0.2Vrms; 100pF <c≤1μf: 1.0±0.2vrms<="" td=""></c≤1μf:>	
3	Insulation Resistances/ (Ri)	$ \begin{array}{c cccc} C0G/C0H(NP0): & C \leq 10nF, & Ri \geq 10000M\Omega \\ & & & C > 10nF, & Ri \times C \geq 500s \\ \hline \\ X7R, & X5R, & X7S: & Y5V: \\ & & C \leq 25nF, & Ri \geq 4000M\Omega \\ & & C > 25nF, & Ri \times C \geq 100s \\ \hline \\ & & C > 25nF, & Ri \times C \geq 100s \\ \hline \end{array} $		Temperature: $18\sim28^{\circ}\text{C}$; Humidity: \leq RH 80%; Apply rated voltage within $60 \pm 5\text{S}$
4	Withstanding voltage (WV)	No breakdown	C0G/C0H(NP0): 3×U _R X7R 、 X5R 、 Y5V 、 X7S: 2.5×U _R t=1minute Charge/discharge current not exceeds 50mA.	

Note: Capacitance test instructions of Class 2 ceramic capacitors

When the capacitor initial capacitance is lower than its tolerance value, the test sample need to be heated for 60 ± 5 minutes at 150 °C ±10 °C. Recover it, let sit at room temperature for 24 ± 2 hrs, and then test the capacitance.

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4.5 Environment Test Specifications and Methods:

Without specific note, the "test method" in Table 6 is based on GB/T 21041/21042 IDT IEC60384-21/22 Table 6 Environment Test Specifications and Methods

No.	Item	Specification	Test Method		
	Temperature	NP0(C0G/C0H): $\alpha_c \le \pm 30 \text{ppm/}^{\circ} \text{C } (125^{\circ} \text{C});$ $-72 \le \alpha_c \le +30 \text{ppm/}^{\circ} \text{C } (-55^{\circ} \text{C});$	Preliminary Drying for 16~24hrs C0G/C0H(NP0),Special preconditioning for 1hr at 150°C followed by 24hrs (X7R、X5R、Y5V),The ranges of capacitance change compared with the		
1	Coefficient of Capacitance	$X7R,X5R: \Delta C/C \le \pm 15\%$	temperature ranges $(\theta 1, 25^{\circ}\text{C}, \theta 2)$ shall be within the specified ranges. X5R: $\theta 1=-55^{\circ}\text{C}$, $\theta 2=85^{\circ}\text{C}$		
1	(α _c) or Temperature	X7S: ΔC/C ≤±22%	X7R \ X7S: $\theta 1 = -33^{\circ}$ C, $\theta 2 = 83^{\circ}$ C X7R \ X7S: $\theta 1 = -55^{\circ}$ C, $\theta 2 = 125^{\circ}$ C Y5V: $\theta 1 = -30^{\circ}$ C, $\theta 2 = 85^{\circ}$ C		
	Characteristics	Y5V: -82%≤∆C/C≤+22%	Test voltage: 0402 X7R 27nF≤C≤100nF: 0.5±0.1Vrms X7S: 0.5±0.2Vrms others: 1.0±0.2Vrms		
2	Resistance to Soldering Heat	Visual: No visible damage and terminations uncovered shall be less than 25%. Capacitance Change: $NP0(C0G/C0H): \ \Delta C/C \leq \pm 2.5\% \text{ or } \pm 0.25 \text{pF}, $ whichever is larger; $X7R, X5R: \Delta C/C \leq \pm 7.5\%; $ $X7S: \ \Delta C/C \leq \pm 15\% $ $Y5V: \ \Delta C/C \leq \pm 20\% $ $tg\delta \text{ and Ri: meet the initial specification in Table 5.}$	Special preconditioning for 1hr at 150 °C followed by 24±1hrs;Preheat the capacitor at 110 to 150 °C for 30-60s. Immerse the capacitor in an eutectic solder solution at 260±5 °C for 10±1 seconds. The depth of immersion is 10mm.Recover it, let sit at room temperature for 6~24hrs [C0G/C0H(NP0)] or 24±2hrs (X7R \ X5R \ Y5V \ X7S), then observe appearance and measure electrical characteristics.		
3	Solderability	75% min. coverage of both terminal electrodes is soldered evenly and continuously.	Immerse the test capacitor into a methanol solution containing rosin for 3 to 5 seconds, preheat it at 80 to 180° C for 30s to 60s and immerse it into molten solder of $235\pm5^{\circ}$ C for 2 ± 0.2 seconds. The depth of immersion is 10mm.		

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	•		
4	Bond Strength of Termination	Visual: No visible damage. Capacitance Change: NP0(C0G/C0H): ΔC/C ≤ ±5% or ±0.5pF, whichever is larger; X7R, X5R X7S: ΔC/C≤±12.5%; Y5V: ΔC/C ≤ ±30%	Solder the capacitor to the test jig (glass epoxy boards) shown in Fig. a. Apply a force in the direction shown in Fig. b. Bending 2mm at a speed of 1mm/sec and hold for 5±1secs, then measure the capacitance. Output
5	Adhesion	Visual: No visible damage.	When Soldering the capacitor on a P. C. board, apply a pushing force of 5N for 10±1 secs. Capacitor P.C. Board

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		Visual: No visible damage.	
6	Vibration	Capacitance Change: NP0(C0G/C0H): Δ C/C \leq \pm 2.5% or \pm 0.25pF, whichever is larger; X7R, X5R: Δ C/C \leq \pm 7.5%; X7S: Δ C/C \leq \pm 15%; Y5V: Δ C/C \leq \pm 20%	Sample shall be mounted on a suitable substrate. Amplitude: 1.5mm Frequencies: 10 Hz~55 Hz and Harmonic vibration of uniform changes, 1 minutes sweep cycle. Repeat this for 2hrs each in 3 perpendicular directions X, Y, Z, total 6hrs. (Related STD: IEC 68-2-6 test Fc)
		tgδ and Ri: meet the initial specification in Table 5.	
		Visual: No visible damage.	
7	Rapid change of temperature	Capacitance Change: NP0(C0G/C0H): Δ C/C \leq \pm 2.5% or \pm 0.25pF, whichever is larger; X7R, X5R: Δ C/C \leq \pm 15%; X7S: Δ C/C \leq \pm 20%; Y5V: Δ C/C \leq \pm 20%	Special preconditioning for 1hr at 150 °C followed by 24hrs. Fix the capacitor to the supporting jig. Expose the capacitors in the condition step 1 through 4 and perform 5 cycles. Step temperature (°C) time 1 θ_A 30 min 2 25 2~5 min 3 θ_B 30 min 4 25 2~5 min NP0(C0G/C0H), X7R,X7S: θ_A =-55 °C, θ_B =125 °C; X5R: θ_A =-55 °C, θ_B =85 °C
		$tg\delta$ and Ri: meet the initial specification in Table 5.	Y5V: θA=-30°C,θB=85°C Recover it, let sit at room temperature for 6~24hrs [C0G/C0H(NP0)] or 24±2hrs (X7R, X5R,Y5V,X7S), then observe appearance and measure electrical characteristics.

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		Visual: No visible damage.	
		Capacitance Change: NP0(C0G/C0H): Δ C/C \leq ±5% or ±0.5pF, whichever is larger; X7R, X5R: Δ C/C \leq ±12.5%; X7S: Δ C/C \leq ±30%; Y5V: Δ C/C \leq ±30%	
8	Damp Heat (Steady State)	$\begin{array}{c} tg\delta: \\ NP0(C0G/C0H): \\ tg\delta \!\! \leq \!\! 20 \! \times \! 10^{-4} \; (C \!\! \geq \!\! 30 pF) \; or \\ tg\delta \!\! \leq \!\! 2 \! \times \! (90/C \!\! + \!\! 7) \! \times \! 10^{-4} (C \!\! < \!\! 30 pF); \\ X7R: tg\delta \!\! \leq \!\! 2 \! \times \! (90/C \!\! + \!\! 7) \! \times \! 10^{-4} (C \!\! < \!\! 30 pF); \\ X7S: tg\delta \!\! \leq \!\! 2 \! \times \! the \; initial \; specification \; in \; Table5; \\ X5R: tg\delta \!\! \leq \!\! 2 \! \times \! the \; initial \; specification \; in \; Table5; \\ X5R: tg\delta \!\! \leq \!\! 1200 \! \times \! 10^{-4} \\ Y5V: U_R \!\! \geq \!\! 25V \qquad tg\delta \!\! \leq \!\! 950 \! \times \! 10^{-4} \\ U_R \!\! = \!\! 16V \qquad tg\delta \!\! \leq \!\! 1300 \! \times \! 10^{-4} \\ U_R \!\! < \!\! 16V \qquad tg\delta \!\! \leq \!\! 1600 \! \times \! 10^{-4}. \end{array}$	Special preconditioning for 1hr at 150°C followed by 24hr Test Temperature: 60°C ±2°C Humidity: RH 90~95% Duration:500hrs Recover it, let sit at room temperature for 6~24hrs [C0G/C0H(NP0)] or 24±2hrs(X7R,X5R,Y5V,X7S), then observe appearance and measure electrical characteristics.
		Ri: NP0(C0G/C0H): Ri \geq 2500M Ω or Ri \times C \geq 50s, which is smaller; X7R,X5R,Y5V,X7S: Ri \geq 1000M Ω or Ri \times C \geq 50s (U _R \geq 25V), which is smaller; Ri \geq 1000M Ω or Ri \times C \geq 10s (U _R \leq 16V), which is smaller.	

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		Visual: No visible damage.	
		Capacitance Change: NP0(C0G/C0H): ΔC/C≤±7.5% or ±0.75pF, which is larger; X7R: ΔC/C≤±12.5%; X7S: ΔC/C≤±30% X5R: ΔC/C≤±15%; Y5V: ΔC/C≤±30%.	Special preconditioning for 1hr at 150° C. Remove and set for 24hours at room temperature. Perform initial measurement. Test Temperature: $60\pm2^{\circ}$ C; Humidity: RH $90\sim95\%$;
9	Damp heat with load	$Tg\delta: \\ NP0(C0G/C0H): \\ tg\delta \leq 50 \times 10^{-4} \ (C \geq 30 pF) \ or \\ tg\delta \leq 5 \times (90/C + 7) \times 10^{-4} (C < 30 pF); \\ X7R: tg\delta \leq 700 \times 10^{-4}; \\ X7S: tg\delta \leq 2 \ \text{whe initial specification in Table5}; \\ X5R: tg\delta \leq 1200 \times 10^{-4}; \\ Y5V: U_R \geq 25V \qquad tg\delta \leq 950 \times 10^{-4}; \\ U_R = 16V \qquad tg\delta \leq 1300 \times 10^{-4}; \\ U_R < 16V \qquad tg\delta \leq 1600 \times 10^{-4}. \\ \end{cases}$	Humidity: RH 90 \sim 95%; Test Voltage: $1.0\times U_R$; Duration: 500hrs; Charge/discharge current not exceeds 50mA. Recover it, let sit at room temperature for $6\sim$ 24hrs [C0G/C0H(NP0)] or 24 \pm 2hrs (X7R,X5R,Y5V,X7S), then observe appearance and measure electrical characteristics. (X5R \geq 100nF Special preconditioning for 1hr at 150 $^{\circ}$ C followed by 24 \pm 4hrs).
		Ri: Ri≥500MΩ or Ri×C≥25s, which is smaller	

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		Visual: No visible damage.	
		Capacitance Change:	
		NP0(C0G/C0H): Δ C/C \leq ±3% or ±0.3pF, which is	
		larger;	
		X7R, X5R: ΔC/C≤±15%;	
		X7S: ΔC/C≤±30%;	Special preconditioning for 1hr at 150 ℃
		Y5V: ΔC/C≤±30%.	followed by 24hrs
		Tgδ:	Test Temperature:
		NP0(C0G/C0H):	NP0(C0G/C0H)/X7R/X7S: 125°C;
		$tg\delta \leq 20 \times 10^{-4} \text{ (C} \geq 30 \text{pF) or}$	`
		$tg\delta \le 2 \times (90/C+7) \times 10^{-4} (C < 30pF);$	X5R/Y5V: 85°C;
		X7R:tgδ≤700×10 ⁻⁴ ;	Duration: 1000hrs;
10	Endurance	X7S:tgδ≤2×the initial specification in Table5;	Test Voltage: 1.5×U _R
10	Endurance	X/S .tg6 $\le 2 \times$ the initial specification in Table5, $X5R$: tg6 $\le 1200 \times 10^{-4}$;	Recover it, let sit at room temperature for
		,	6~24hrs [C0G/C0H(NP0)] or 24±2hrs
		Y5V:U _R ≥25V $tg\delta$ ≤950×10 ⁻⁴	(X7R,X5R,Y5V,X7S) , then observe
		$U_{R} = 16V \qquad tg\delta \leq 1300 \times 10^{-4}$	appearance and measure electrical
		$U_R < 16V tg\delta \le 1600 \times 10^{-4}$.	characteristics. (X5R≥100nF Special
		Ri:	preconditioning for 1hr at 150°C followed
		NP0(C0G/C0H): Ri \geq 1000MΩ or Ri \times C \geq 50s,which	by 24±4hrs).
		is smaller;	
		X7R,X5R,Y5V,X7S:	
		$Ri \ge 1000M\Omega$ or $Ri \times C \ge 50s$ ($U_R \ge 25V$), which is	
		smaller;	
		$Ri \ge 1000M\Omega$ or $Ri \times C \ge 10s$ ($U_R \le 16V$), which is	
		smaller.	
		Smanor.	

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- 5. Packaging, Shipment and storage:
- 5.1 Packing:
- 5.1.1 Packing type:

Reel Packaging (standard carrier tape disc packaging), single disc smallest package are shown in Table 4.

5.1.2 Carrier Tape size:

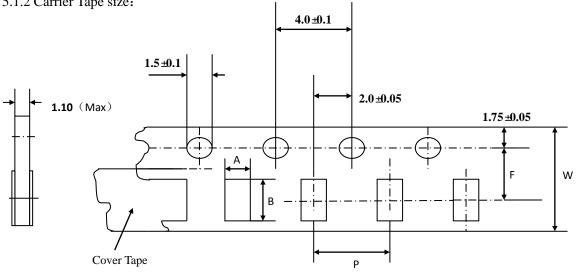


Figure 2 Carrier

Table 7 Carrier size

	Size of product					
Mark	0402	0603	0805	1206		
	Size (Unit: mm)					
A (Width of the square hole)	0.70 ± 0.10	1.00±0.20	1.60±0.20	2.00±0.20		
B (Length of the square hole)	1.20±0.10	1.80±0.20	2.40±0.20	3.60±0.20		
F (Center distance between positioning hole and square hole)	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05		
P (Square hole spacing)	2.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10		
W (Width of carrier)	8.00±0.20	8.00±0.20	8.00±0.20	8.00±0.20		

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5.1.3 Disc size:

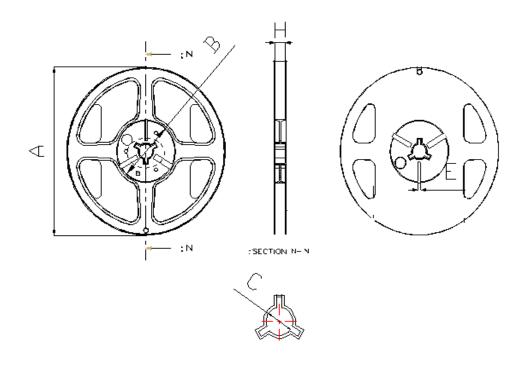
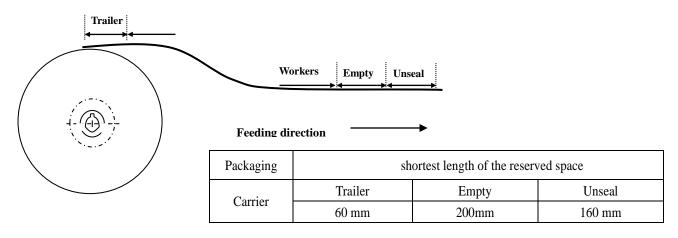


Figure 3 Disc

Table 8 Disc size

Disc Size	A/mm	B/mm	C/mm	E/mm	H/mm
7"	Ф178±2.0	Ф60±2.0	Ф13±1.0	4±1.0	9.5±1.0
13"	Ф330±2.0	Ф100±2.0	Ф13±1.0	3±1.0	10±1.0

5.1.4 Carrier specifications:



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5.1.5 Performance of Carrier Taping:

5.1.5.1 Strength of Carrier Tape and Top Cover Tape:

a. Carrier Tape

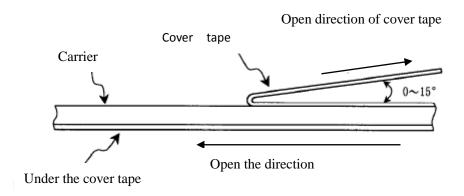
When a tensile force 1.02kgf is applied in the direction to unreel the tape, the tape shall withstand this force.

b. Top cover Tape

When a tensile force 1.02kgf is applied to the tape, the tape shall withstand this force.

5.1.5.2 Peeling Strength of Top Cover Tape:

Unless otherwise specified, the peeling strength of top cover tape shall be within 10.2 to 71.4 gf when the top cover tape is pulled at a speed of 300mm/min with the angle of 0 to 15 (see the following figure).



5.2 Shipment:

It must not be got rain, snow, and must avoid erosion of acid and alkali during the course of shipment.

5.3 Storage:

Period of Store:

12 months, otherwise, its solderability must be inspected again.

Condition of Store:

Temperature: Below 35° C Humidity: Below RH70%.

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NIN-FC2R7JTRF NMC0201X5R474K4TRPF NMC0402NPO220J50TRPF NMC0402X5R105K6.3TRPF NMC0402X5R224K6.3TRPF

NMC0402X7R103J25TRPF NMC0402X7R153K16TRPF NMC0603NPO1R8C50TRPF NMC0603NPO20J50TRPF

NMC0603NPO330G50TRPF NMC0603X5R475M6.3TRPF NMC0805NPO270J50TRPF NMC0805NPO820J50TRPF

NMC0805X7R224K16TRPLPF NMC0805X7R224K25TRPF NMC1206X7R102K50TRPF NMC1206X7R106K10TRPLPF

NMC1206X7R475K10TRPLPF NMC-H0805X7R472K250TRPF NMC-L0402NPO7R0C50TRPF NMC-L0603NPO2R2B50TRPF NMC-Q0402NPO8R2D200TRPF C1206C101J1GAC C1608C0G2A221J C1608X7R1E334K C2012C0G2A472J 2220J2K00562KXT

1812J2K00332KXT CDR31BX103AKWR CDR33BX104AKUR CDR33BX683AKUS CGA2B2C0G1H010C CGA2B2C0G1H040C

CGA2B2C0G1H050C CGA2B2C0G1H060D CGA2B2C0G1H070D CGA2B2C0G1H120J CGA2B2C0G1H151J

CGA2B2C0G1H381JT0Y0F CGA2B2C0G1H1R5C CGA2B2C0G1H2R2C CGA2B2C0G1H390J CGA2B2C0G1H391J

CGA2B2C0G1H3R3C